

AEM15820

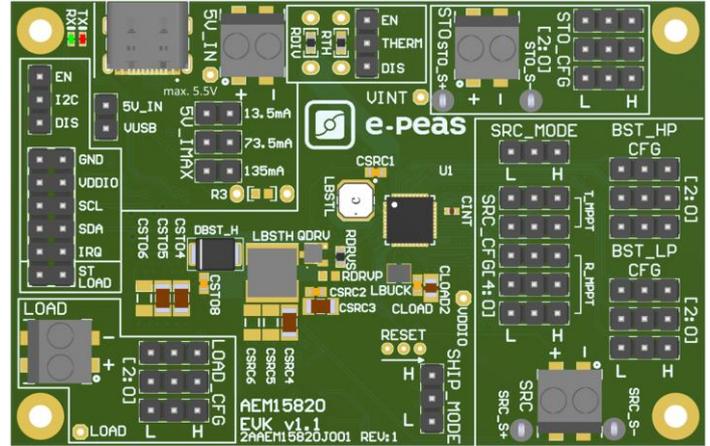
Quick Start Guide EVK



FEATURES

Connectors

- 1 screw connector for the source
- 1 screw connector for the storage element
- 1 screw connector for the application circuit
- 1 screw connector for 5 V DC power input
- 1 USB connector for alternative 5 V DC power input / USB to I²C converter



Configuration

- 1 header SRC_MODE to configure the source voltage regulation mode
- 5 headers SRC_CFG[4:0] to configure the source regulation voltage
- 3 headers BST_LP_CFG[2:0] to configure the low-power boost converter timings
- 3 headers BST_HP_CFG[2:0] to configure the high-power boost converter timings
- 3 headers STO_CFG[2:0] to configure the storage element protection thresholds
- 3 headers LOAD_CFG[2:0] to configure the LOAD output regulation voltage
- 1 header THERM to enable/disable the thermal monitoring
- 1 header to enable/disable the I²C functionalities
- 1 header (6 pins) to connect the I²C communication related pins and the ST_LOAD signal
- 3 headers to configure the 5 V charge current
- 1 header to enable/disable the shipping mode

Size

- 76 mm x 49 mm.
- 4 x M2.5 mounting holes.

SUPPORT PCB

BOM around the AEM15820

Designator	Description	Quantity	Manufacturer	Part Number
U1	AEM15820 QFN40	1	e-peas	Order at sales@e-peas.com
CINT	Ceramic Cap 10 µF, 6.3 V, 20 %, X5R, 0402	1	Murata	GRM155R60J106ME44D
CSTO	Ceramic Cap 47 µF, 6.3 V, 20 %, X5R, 0603	1	Murata	GRM188R60J476ME15D
CSTO2	Ceramic Cap 220 µF, 6.3 V, 20 %, X5R, 1206	1	Murata	GRM31CR60J227ME11L
CSTOHP1	Ceramic Cap 47 µF, 6.3 V, 20 %, X5R, 0603	1	Murata	GRM188R60J476ME15D
CSRC1	Ceramic Cap 22 µF, 10 V, 20 %, X5R, 0603	1	Murata	GRM188R61A226ME15D
CSRC2 to CSRC9	Ceramic Cap 220 µF, 6.3 V, 20 %, X5R, 1206	1	Murata	GRM31CR60J227ME11L
LBOOST_LP	Power inductor 33 µH, 0.68 A, LPS4018	1	Coilcraft	LPS4018-333MRB
LBOOST_HP	Power inductor 3.3 µH, 10 A, MAPI-5030	1	Würth	74438367033
DBOOST_HP	Schottky Diode 1A	1	Vishay	VS-10BQ015HM3/5BT
QDRV	N-MOS Transistor, 25 V, 100 A, 2 mΩ	1	Infineon	ISK024NE2LM5
QP_PG	P-MOS Transistor, 20 V, 70 A, 6.5 mΩ	1	Diodes Inc.	DMP2005UFG
QN_PG	N-MOS Transistor, 60 V, 230 mA, 3.5 Ω	1	Infineon	B5S138NH6327XTSA2
RPG_PU	Resistor 330 kΩ	1	Yageo	RC0603FR-07330KL
RDRV_PD	Resistor 330 kΩ	1	Yageo	RC0603FR-07330KL
CLOAD	Ceramic Cap 22 µF, 10 V, 20 %, X5R, 0603	1	Murata	GRM188R61A226ME15D
LBUCK	Power inductor 10 µH	1	TDK	VLS252012CX-100M-1
C5	Ceramic Cap 47 µF, 25 V, 20 %, X5R 1206	1	TDK	C3216X5R1E476M160AC
R1	Resistor 2.2 Ω	1	TE	CRGQ2512J2R2
D5	Zener diode 5.1V	1	ON Semi	1SMB5918BT3G
RSCL	Resistor 1 kΩ	1	Multicomp	MCWR06X1001FTL
RSDA	Resistor 1 kΩ	1	Multicomp	MCWR06X1001FTL
RDIV	Resistor 22 kΩ	1	Yageo	RC0402FR-0722KL
RTH	10 kΩ NTC thermistor	1	Murata	NCP15XH103J03RC

Footprint & Symbol: Information available on the datasheet





STEP 1: Configure the AEM15820

- SRC voltage regulation:**

SRC_MODE and SRC_CFG[4:0] (seen as HIGH if left floating)

If SRC_MODE = L (constant voltage):

Configuration pins					Voltage [V]
SRC_CFG[4:0]					$V_{SRC,REG}$
L	L	L	L	L	Reserved ¹
L	L	L	L	H	0.30
L	L	L	H	L	0.35
L	L	L	H	H	0.41
L	L	H	L	L	0.45
L	L	H	L	H	0.50
L	L	H	H	L	0.56
L	L	H	H	H	0.60
L	H	L	L	L	0.65
L	H	L	L	H	0.71
L	H	L	H	L	0.75
L	H	L	H	H	0.80
L	H	H	L	L	0.86
L	H	H	L	H	0.90
L	H	H	H	L	0.95
L	H	H	H	H	1.01

Configuration pins					Voltage [V]
SRC_CFG[4:0]					$V_{SRC,REG}$
H	L	L	L	L	1.10
H	L	L	L	H	1.20
H	L	L	H	L	1.31
H	L	L	H	H	1.40
H	L	H	L	L	1.50
H	L	H	L	H	1.59
H	L	H	H	L	1.70
H	L	H	H	H	1.79
H	H	L	L	L	1.90
H	H	L	L	H	1.99
H	H	L	H	L	2.19
H	H	L	H	H	2.41
H	H	H	L	L	2.59
H	H	H	L	H	2.82
H	H	H	H	L	3.00
H	H	H	H	H	3.18

1. This reserved configuration must not be used

If SRC_MODE = H (MPPT ratio):

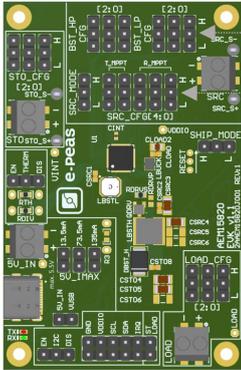
Configuration pins				MPPT Ratio
SRC_CFG[2:0]				R_{MPPT}
L	L	L	L	Reserved
L	L	H	L	50 %
L	H	L	L	65 %
L	H	H	L	70 %
H	L	L	L	75 %
H	L	H	L	80 %
H	H	L	L	85 %
H	H	H	L	Reserved

Configuration pins	MPPT wait time [ms]	MPPT Period [ms]	
SRC_CFG[4:3]	$T_{MPPT,WAIT}^1$	$T_{MPPT,PERIOD}$	
L	L	1.8	116
L	H	7.3	465
H	L	29	1862
H	H	233	14895

1. The total time in open-circuit is the sum of $T_{MPPT,WAIT}$ (see table above) plus $T_{MPP,MEASURE}$ (fixed to 1.36ms).

- LP and HP boost timing multipliers:** BST_LP_CFG[2:0] and BST_HP_CFG[2:0] (seen as HIGH if left floating)

Configuration pins			Boost timing multiplier
BST_LP_CFG[2:0] BST_HP_CFG[2:0]			T_{MULT}
L	L	L	x1
L	L	H	x2
L	H	L	x3
L	H	H	x4
H	L	L	x6
H	L	H	x8
H	H	L	x12
H	H	H	x16

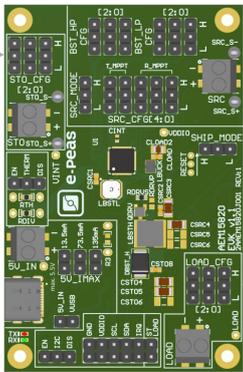




- **Storage element protection thresholds: STO_CFG[2:0]** (seen as HIGH if left floating)

Configuration pins			Overdischarge voltage [V]	Charge ready voltage [V]	Overcharge voltage [V]	Storage element type
STO_CFG[2:0]			V_{OVDIS}	V_{CHRDY}	V_{OVCH}	
L	L	L	2.51	2.61	3.79	Lithium-ion Super Capacitor (LiC)
L	L	H	2.51	2.61	3.49	Lithium-ion Super Capacitor 85 °C (LiC)
L	H	L	3.00	3.21	4.13	Lithium-ion
L	H	H	3.00	3.21	3.90	Lithium-ion (long life)
H	L	L	3.51	3.60	3.90	Lithium-ion (super long life)
H	L	H	3.00	3.60	4.35	Lithium Polymer (LiPo), NiMH
H	H	L	2.81	3.11	3.62	Lithium Iron Phosphate (LiFePO4)
H	H	H	2.61	2.70	3.90	Tadiran HLC1020

If the LOAD output is used and configured with the headers (not by I²C), the $V_{CHRDY,BUCK}$ threshold will be configured automatically in function of the STO_CFG[2:0] and V_{LOAD} settings:



Configuration pins			Buck charge ready voltage [V]				Storage element type
STO_CFG[2:0]			$V_{CHRDY,BUCK}$ for $V_{LOAD} \leq 2.5$ V	$V_{CHRDY,BUCK}$ for $V_{LOAD} = 2.8$ V	$V_{CHRDY,BUCK}$ for $V_{LOAD} = 3.0$ V	$V_{CHRDY,BUCK}$ for $V_{LOAD} = 3.3$ V	
L	L	L	2.61	2.91	3.11	3.41	Lithium-ion Super Capacitor (LiC)
L	L	H	2.61	2.91	3.11	3.41	Lithium-ion Super Capacitor 85 °C (LiC)
L	H	L	3.21	3.21	3.21	3.51	Lithium-ion
L	H	H	3.21	3.21	3.21	3.51	Lithium-ion (long life)
H	L	L	3.60	3.60	3.60	3.60	Lithium-ion (super long life)
H	L	H	3.60	3.60	3.60	3.60	Lithium Polymer (LiPo), NiMH
H	H	L	3.11	3.11	3.21	3.41	Lithium Iron Phosphate (LiFePO4)
H	H	H	2.70	2.91	3.11	3.41	Tadiran HLC1020

- **Load voltage regulation: LOAD_CFG[2:0]** (seen as HIGH if left floating)

Configuration pins			LOAD voltage [V]
LOAD_CFG[2:0]			V_{LOAD}
L	L	L	Buck disabled
L	L	H	1.5
L	H	L	1.8
L	H	H	2.2
H	L	L	2.5
H	L	H	2.8
H	H	L	3.0
H	H	H	3.3



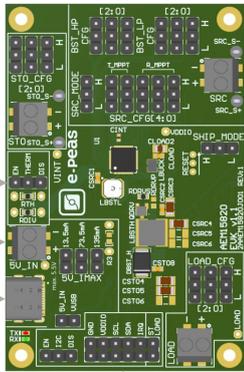


- **5 V charger maximum current:** the maximum charging current can be configured with a jumper (135 mA, 73.5 mA and 13.5 mA) or by mounting R3 resistor (e.g., 1.5 k Ω resistor for 33.3 mA).

Resistor [Ω]	Maximum Charging Current [mA]
R_{5V_IMAX}	I_{5V_CC}
370	135.0
680	73.5
1500	33.3
3700	13.5

- **Thermal monitoring:** connect the jumper THERM to EN/DIS to enable/disable the thermal monitoring feature.

For preconfigured temperature thresholds, see “Storage Element Thresholds” section in the datasheet.



- **I²C communication:** all the configurations of the AEM, as well as various information, are available through I²C communication. See the datasheet for more details.

Please note that, while ST_LOAD shares the same header as the I²C interface, its power domain is not VDDIO but V_{LOAD} .

- **USB to I²C converter:** to use the “I²C Configuration Tool” for easy configuration of all I²C functionalities, install jumpers on VDDIO, SDA, SCL and IRQ on the I²C communication header and connect the EVK to a computer through the USB connector.

The USB connector can also be used as an alternative power source for the 5 V charger. To do so, install a jumper on the “5V_IN-VUSB” header.

STEP 2: Connect the storage element with a voltage higher than 2.4 V.

STEP 3: Connect the application circuit.

STEP 4: Connect the source or the 5 V power input.

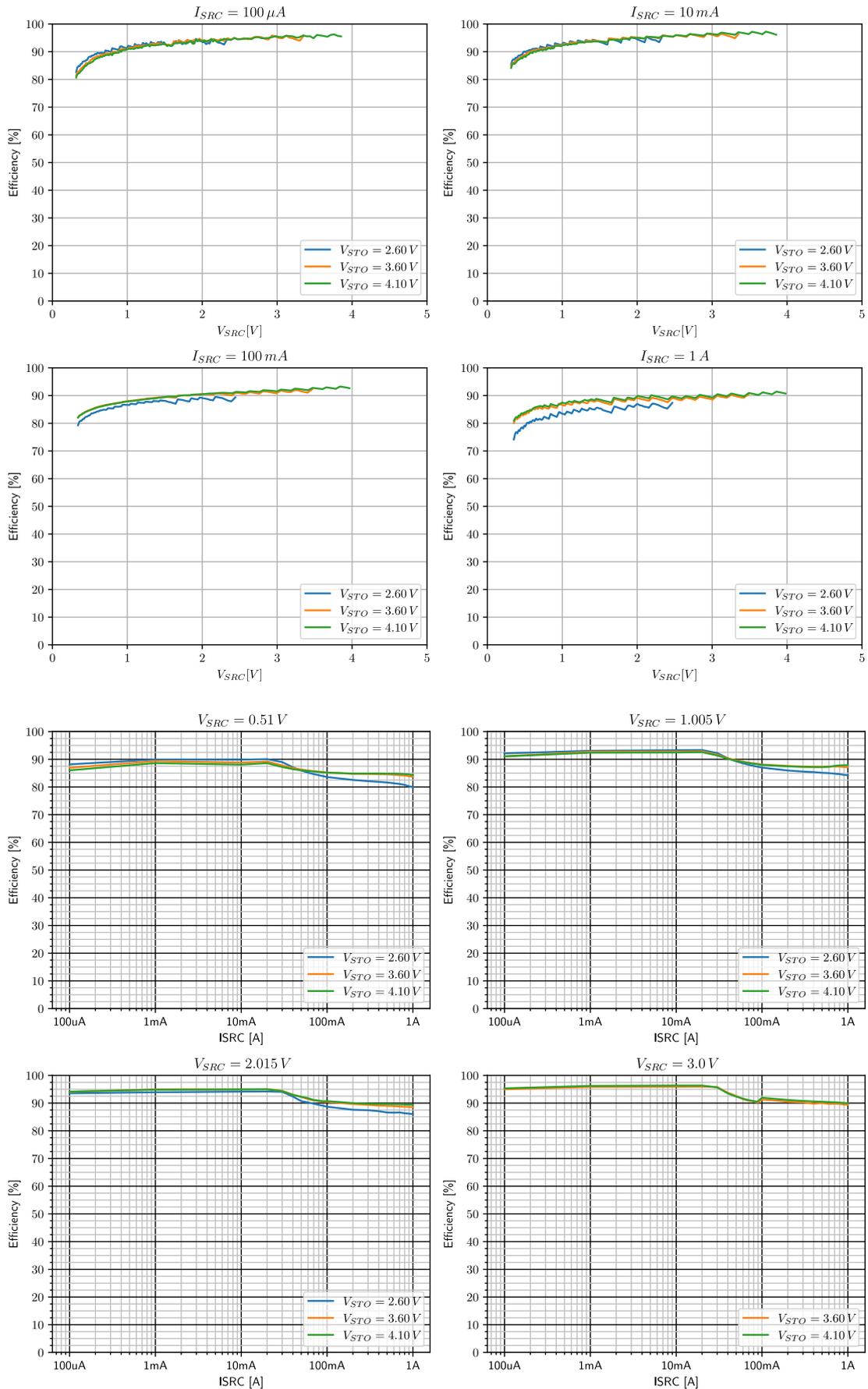




Boost efficiency:

$L_{\text{BOOSTLP}} = 33 \mu\text{H}$ Coilcraft LPS4018-333MRB, timing x3

$L_{\text{BOOSTHP}} = 3.3 \mu\text{H}$ Würth 74438367033, timing x6





Buck efficiency:

$L_{BUCK} = 10 \mu\text{H}$ TDK VLS252012CX-100M-1, timing x2

